

INVENTOR INFORMATION

Inventor One Given Name:: Jian
Family Name:: Wu
Postal Address Line One:: Blk 786, Yishun Ring Road, #07-3502
City:: Singapore
Country:: Singapore
Postal or Zip Code:: 760786
Citizenship Country:: People's Republic of China
Inventor Two Given Name:: Yan
Family Name:: Zhou
Postal Address Line One:: Blk 56, Choa Chu Kang North 6
Postal Address Line Two:: Yew Mei Green, #13-36
City:: Singapore
Country:: Singapore
Postal or Zip Code:: 689577
Citizenship Country:: People's Republic of China
Inventor Three Given Name:: Shu Chuen
Family Name:: Ho
Postal Address Line One:: Blk 806, Thomson Road, #05-11
City:: Singapore
Country:: Singapore
Postal or Zip Code:: 298189
Citizenship Country:: Singapore
Inventor Four Given Name:: Teng Hock
Family Name:: Kuah
Postal Address Line One:: Blk 321, Yishun Central, #08-315
City:: Singapore
Country:: Singapore
Postal or Zip Code:: 760321
Citizenship Country:: Singapore

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 000002352
Electronic Mail One:: email@ostrolenk.com

APPLICATION INFORMATION

Title Line One:: METHOD OF MANUFACTURING AN IC PACKAGE
Total Drawing Sheets:: 3
Formal Drawings?: Yes
Application Type:: Utility
Docket Number:: P/4076-5
Secrecy Order in Parent Appl.?: No

Source:: PrintEFS Version 1.0.1